

# **CRYSTAL OSCILLATOR (SPXO)**

**OUTPUT: CMOS** 





Product Number (please contact us) SG2016CAN: X1G004801xxxx00 SG-210STF: X1G004171xxxx00 SG3225CAN: X1G005961xxxx15 SG5032CAN: X1G004451xxxx00 SG7050CAN: X1G004481xxxx00

# SG2016 / 3225 / 5032 / 7050CAN SG-210STF

Frequency
 Supply voltage
 Function
 Operating temperature
 20 standard frequencies
 1.8 V to 3.3 V Typ.
 Standby(ST)
 40 °C to +105 °C











SG2016CAN (2.0 x 1.6 mm)

SG-210STF (2.5 x 2.0 mm)

SG3225CAN (3.2 x 2.5 mm)

SG5032CAN (5.0 x 3.2 mm)

SG7050CAN (7.0 x 5.0 mm)

### Specifications (characteristics)

Item	Symbol		Specificatio	ns	Conditions / Remarks						
Output frequency	fo	14.7456 MHz 16 25 MHz 26	MHz 10 MHz MHz 20 MHz MHz 27 MHz MHz 48 MHz	12 M 24 M 32 M 50 M	MHz 24 MHz 3	2.288 MHz 4.576 MHz 3.33 MHz 72 MHz					
Supply voltage	Vcc		1.60 V to 3.63 1.71 V to 3.63	3 V			fo = 72 l	4 MHz ≤ fo ≤ 50 MHz, T_use = +105 °C Max. fo = 72 MHz, T_use = +85 °C Max.			
	T .		2.25 V to 3.63 V fo = 72 MHz, T_use = +105 °C Max.  -55 °C to +125 °C SG2016CAN								
Storage temperature	T_stg	-40 °C to +125 °C				All other	s				
Operating temperature	T_use	-20 °C to +70 °	C, -40 °C to +85 °	°C, -40	°C to +10	05 °C	See of figure *1				
F	f 4-1	±25 × 10 <sup>-6</sup>				-20 °C to +70 °C					
Frequency tolerance	f_tol		±50 × 10 <sup>-6</sup>				-40 °C to	+85 °C, -40 °C	to +105 °C		
		Vcc = 1.8 V ± 10 %	Vcc = 2.5 V ± 1	0 %	V <sub>CC</sub> = 3.3	3 V ± 10 %					
		1.5 mA Max.	1.6 mA Max		1.8 m	nA Max.	No load condition, 4 MHz ≤ fo ≤ 20 MHz				
Current consumption	Icc	1.8 mA Max.	2.0 mA Max		2.2 m	nA Max.	No load condition, 20 MHz < fo ≤ 40 MHz				
		2.1 mA Max.	2.4 mA Max		2.6 m	nA Max.	No load condition, 40 MHz < fo ≤ 50 MHz				
		2.4 mA Max.	2.8 mA Max		3.0 m	nA Max.	No load condition, fo = 72 MHz				
Stand-by current	I_std	2.1 µA Max.	2.5 µA Max		2.7 μ	A Max.	ST =GND				
Symmetry	SYM		45 % to 55 %	%			50 % V <sub>CC</sub> level, L_CMOS ≤ 15 pF				
	Voh	90 % V <sub>CC</sub> Min.					1.8 V ± 10 %	2.5 V ± 10 %	3.3 V ± 10 %		
0	VoL	10 % V <sub>CC</sub> Max.				I <sub>OH</sub>	-1.5 mA 1.5 mA	-3 mA 3 mA	-4 mA 4 mA		
Output voltage	V <sub>OH-2</sub>	V <sub>CC</sub> - 0.4 V Min.					1.8 V±10 %	2.5 V±10 %	3.3 V±10 %		
	V <sub>OL-2</sub>	0.4 V Max.					I <sub>OH</sub>	-3 mA 3 mA	-4 mA 4 mA	-6 mA 6 mA	
Output load condition (CMOS)	L_CMOS	15 pF Max.									
Input voltage	V <sub>IH</sub>	80 % Vcc Min.				ST terminal					
Input voltage	V <sub>IL</sub>	20 % V <sub>CC</sub> Max.									
Rise time and Fall time	tr / tf	3 ns Max. 3.5 ns Max. (@1.8 V±10 %)				20 % V <sub>CC</sub> to 80 % V <sub>CC</sub> level, L_CMOS = 15 pF					
Start-up time	t_str	3 ms Max. T = 0 at 90 % V <sub>CC</sub>									
Frequency aging	f_age		$\pm 3 \times 10^{-6}$ / year	Мах.			+25 °C,	+25 °C, First year			

[Model: SG2016/3225/5032/7050CAN]

⑤Frequency tolerance ⑥Operating temperature range

①Internal identification code("A" is default)

<b> ④</b> Su	pply voltage *See Figure 1	
Т	1.8 V to 3.3 V Typ.	
K	2.5 V to 3.3 V Typ.	

⑤Frequency tolerance / ⑥Operating temperature range				
DB*	±25 × 10 <sup>-6</sup> / -20 °C to +70 °C			
JG	±50 × 10 <sup>-6</sup> / -40 °C to +85 °C			
JH	±50 × 10 <sup>-6</sup> / -40 °C to +105 °C			

<sup>\*</sup> Please refer to Product number list on Full Data Sheet for available frequencies

[Model: SG-210STF]

3St	upply voltage *See Figure 1	⑤Frequency to		
Т	1.8 V to 3.3 V Typ.	S*	±25 × 1	
		L	±50 × 1	
		V	. FO	

	⑤Free	uency tolerance			
Γ	S*	±25 x 10 <sup>-6</sup> / -20 °C to +70 °C			
Г	L	±50 × 10 <sup>-6</sup> / -40 °C to +85 °C			
Г	Υ	±50 × 10 <sup>-6</sup> / -40 °C to +105 °C			

<sup>\*</sup> Please refer to Product number list on Full Data Sheet for available frequencies

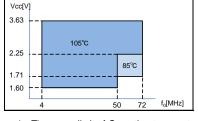
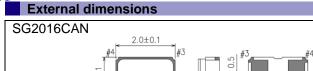
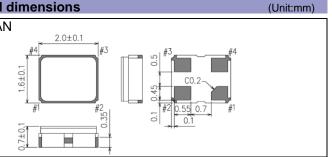
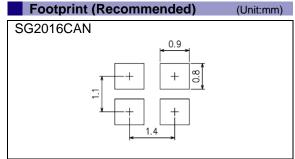


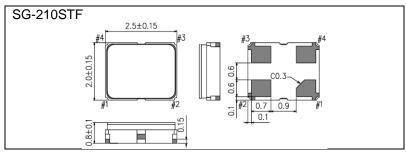
Figure 1 : The upper limit of Operating temperature and the related conditions

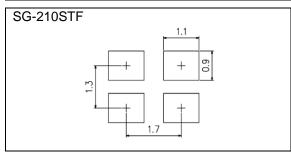
Please note that Supply voltage range (Vcc) depends on Output frequency (fo) and upper limit of Operationg temperature (T\_use Max.).

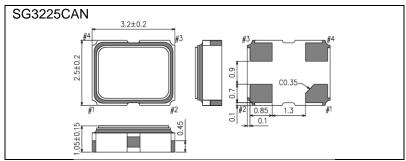


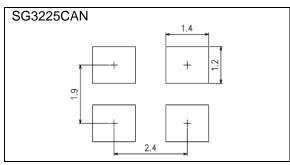


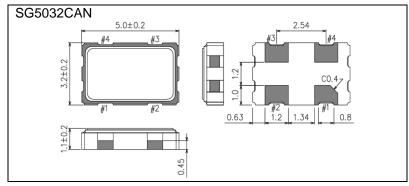


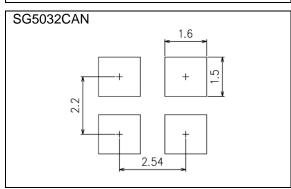


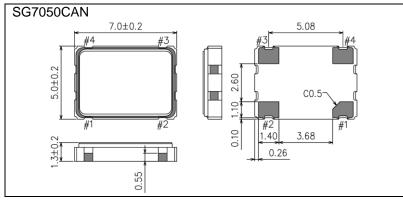


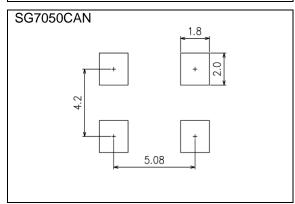












## Pin Map

Pin	Connection		Function							
	ST	ST term	ST terminal							
1			ST function	Oscillator circuit	Output					
'	31		HIGH or "open"	Oscillation	Specified frequency: Enable	1				
			LOW	Oscillation stop	High impedance: Disable					
2	GND	Ground								
3	OUT	Clock ou	Clock output							
4	V <sub>cc</sub>	Power s	upply							

■Notes: To maintain stable operation, provide a 0.01uF to 0.1uF by-pass capacitor at a location as near as possible to the power source terminal of the crystal product (between Vcc - GND).

# PROMOTION OF ENVIRONMENTAL MANAGEMENT SYSTEM CONFORMING TO INTERNATIONAL STANDARDS

At Seiko Epson, all environmental initiatives operate under the Plan-Do-Check-Action (PDCA) cycle designed to achieve continuous improvements. The environmental management system (EMS) operates under the ISO 14001 environmental management standard.

All of our major manufacturing and non-manufacturing sites, in Japan and overseas, completed the acquisition of ISO 14001 certification.

ISO 14000 is an international standard for environmental management that was established by the International Standards Organization in 1996 against the background of growing concern regarding global warming, destruction of the ozone layer, and global deforestation.

### **WORKING FOR HIGH QUALITY**

In order provide high quality and reliable products and services than meet customer needs, Seiko Epson made early efforts towards obtaining ISO9000 series certification and has acquired ISO9001 for all business establishments in Japan and abroad. We have also acquired IATF 16949 certification that is requested strongly by major automotive manufacturers as standard.

IATF 16949 is the international standard that added the sector-specific supplemental requirements for automotive industry based on ISO9001.

Explanation of the mark that are using it for the catalog



►Pb free.



► Complies with EU RoHS directive.

\*About the products without the Pb-free mark.

Contains Pb in products exempted by EU RoHS directive.

(Contains Pb in sealing glass, high melting temperature type solder or other.)



▶ Designed for automotive applications such as Car Multimedia, Body Electronics, Remote Keyless Entry etc.



▶ Designed for automotive applications related to driving safety (Engine Control Unit, Air Bag, ESC etc.).

#### 

- The content of this document is subject to change without notice. Before purchasing or using Epson products, please contact with sales
  representative of Seiko Epson Corporation ("Epson") for the latest information and be always sure to check the latest information
  published on Epson's official web sites and resources.
- 2. This document may not be copied, reproduced, or used for any other purposes, in whole or in part, without Epson's prior consent.
- 3. Information provided in this document including, but not limited to application circuits, programs and usage, is for reference purpose only. Epson makes no guarantees against any infringements or damages to any third parties' intellectual property rights or any other rights resulting from the information. This document does not grant you any licenses, any intellectual property rights or any other rights with respect to Epson products owned by Epson or any third parties.
- 4. Using Epson products, you shall be responsible for safe design in your products; that is, your hardware, software, and/or systems shall be designed enough to prevent any critical harm or damages to life, health or property, even if any malfunction or failure might be caused by Epson products. In designing your products with Epson products, please be sure to check and comply with the latest information regarding Epson products (including, but not limited to this document, specifications, data sheets, manuals, and Epson's web site). Using technical contents such as product data, graphic and chart, and technical information, including programs, algorithms and application circuit examples under this document, you shall evaluate your products thoroughly both in stand-alone basis and within your overall systems. You shall be solely responsible for deciding whether to adopt/use Epson products with your products.
- 5. Epson has prepared this document carefully to be accurate and dependable, but Epson does not guarantee that the information is always accurate and complete. Epson assumes no responsibility for any damages you incurred due to any misinformation in this document.
- 6. No dismantling, analysis, reverse engineering, modification, alteration, adaptation, reproduction, etc., of Epson products is allowed.
- 7. Epson products have been designed, developed and manufactured to be used in general electronic applications and specifically designated applications ("Anticipated Purpose"). Epson products are NOT intended for any use beyond the Anticipated Purpose that requires particular quality or extremely high reliability in order to refrain from causing any malfunction or failure leading to critical harm to life and health, serious property damage, or severe impact on society, including, but not limited to listed below ("Specific Purpose"). Therefore, you are strongly advised to use Epson products only for the Anticipated Purpose. Should you desire to purchase and use Epson products for Specific Purpose, Epson makes no warranty and disclaims with respect to Epson products, whether express or implied, including without limitation any implied warranty of merchantability or fitness for any Specific Purpose. Please be sure to contact our sales representative in advance, if you desire Epson products for Specific Purpose:

Space equipment (artificial satellites, rockets, etc.)/ Transportation vehicles and their control equipment (automobiles, aircraft, trains, ships, etc.) / Medical equipment/ Relay equipment to be placed on sea floor/ Power station control equipment / Disaster or crime prevention equipment/Traffic control equipment/ Financial equipment

Other applications requiring similar levels of reliability as the above

- 8. Epson products listed in this document and our associated technologies shall not be used in any equipment or systems that laws and regulations in Japan or any other countries prohibit to manufacture, use or sell. Furthermore, Epson products and our associated technologies shall not be used for the purposes of military weapons development (e.g. mass destruction weapons), military use, or any other military applications. If exporting Epson products or our associated technologies, please be sure to comply with the Foreign Exchange and Foreign Trade Control Act in Japan, Export Administration Regulations in the U.S.A (EAR) and other export-related laws and regulations in Japan and any other countries and to follow their required procedures.
- 9. Epson assumes no responsibility for any damages (whether direct or indirect) caused by or in relation with your non-compliance with the terms and conditions in this document or for any damages (whether direct or indirect) incurred by any third party that you give, transfer or assign Epson products.
- 10. For more details or other concerns about this document, please contact our sales representative.
- 11. Company names and product names listed in this document are trademarks or registered trademarks of their respective companies.